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APPLICATION NO. FILING DATE FIRST NAMED INVENTOR ATTORNEY DOCKET NO. \mathbf{B} 851063.425 MURARI 06/19/98 09/100,838 **EXAMINER** MMC2/0410 000500 SEED INTELLECTUAL PROPERTY LAW GROUP PLL KWOK, H 701 FIFTH AVE **ART UNIT** PAPER NUMBER SUITE 6300 2856 SEATTLE WA 98104-7092 DATE MAILED: 04/10/01

Please find below and/or attached an Office communication concerning this application or proceeding.

Commissioner of Patents and Trademarks

Office Action Summary

Application No. 09/100,838

Applicant(s)

Murari et al.

Examiner

H. Kwok

Group Art Unit 2856

X Responsive to communication(s) filed on Jan 16, 2001	
X This action is FINAL.	•
Since this application is in condition for allowance except for in accordance with the practice under <i>Ex parte Quayle</i> , 1935	formal matters, prosecution as to the merits is closed C.D. 11; 453 O.G. 213.
A shortened statutory period for response to this action is set to is longer, from the mailing date of this communication. Failure to application to become abandoned. (35 U.S.C. § 133). Extension 37 CFR 1.136(a).	O respond within the period for recovery
Disposition of Claims	
	is/are pending in the application.
Of the above, claim(s) 8-11	
Claim(s)	in/ore elleved
☐ Claim(s) 1-7, 12, 13, and 15-20	
☐ Claim(s)	is/are objected to.
Claims	are subject to restriction or election requirement.
Application Papers	
☐ See the attached Notice of Draftsperson's Patent Drawing I	
☐ The drawing(s) filed on is/are objected	d to by the Examiner.
☐ The proposed drawing correction, filed on	is 🗀 pproved 🗀 disapproved.
\square The specification is objected to by the Examiner.	
\square The oath or declaration is objected to by the Examiner.	
Priority under 35 U.S.C. § 119	
Acknowledgement is made of a claim for foreign priority un	nder 35 U.S.C. § 119(a)-(d).
☐ All ☐ Some* ☐ None of the CERTIFIED copies of the	
received.	, , , , , , , , , , , , , , , , , , , ,
\square received in Application No. (Series Code/Serial Number	er)
\square received in this national stage application from the Int	ternational Bureau (PCT Rule 17 2(a))
*Certified copies not received:	, or not 1712(e)//
Acknowledgement is made of a claim for domestic priority u	under 35 U.S.C. § 119(e).
ttachment(s)	
☐ Notice of References Cited, PTO-892	
	s). 16
☐ Interview Summary, PTO-413	**
☐ Notice of Draftsperson's Patent Drawing Review, PTO-948	
☐ Notice of Informal Patent Application, PTO-152	
SEE OFFICE ACTION ON THE	FOLLOWING PAGES

Application/Control Number: 09/100,838

Art Unit: 2856

DETAILED ACTION

Claim Rejections - 35 U.S.C. § 103

- 1. The following is a quotation of 35 U.S.C. 103(a) which forms the basis for all obviousness rejections set forth in this Office action:
 - (a) A patent may not be obtained though the invention is not identically disclosed or described as set forth in section 102 of this title, if the differences between the subject matter sought to be patented and the prior art are such that the subject matter as a whole would have been obvious at the time the invention was made to a person having ordinary skill in the art to which said subject matter pertains. Patentability shall not be negatived by the manner in which the invention was made.
- 2. Claims 1-7, 12-13 and 15-20 are rejected under 35 U.S.C. 103(a) as being unpatentable over U.S. Patent 5,864,063 (Otani et al.) in view of WO 96/39632 (Martin et al.).

Otani et al. discloses an electrostatic capacitive type acceleration sensor comprising, as illustrated in Figures 1-9, sensor unit 2 formed in a first chip of semiconductor material 4 for producing an electrical signal dependent on a movement of a sensing element including at least one movable microstructure 14 relative to a surface of the first chip wherein the sensing element 14 is formed on the chip; a hollow structure (as observed in the figure) formed by a second semiconductor chip 3 attached to the first chip encloses the sensitive element; a processing circuit 6 for precessing the electrical signal formed in the second chip and in electrical connection with the electrical signal produced by the sensing element. (See, column 3, line 10 to column 4, line 47). The only difference between the prior art and the claimed invention is the hollow structure includes a metal wall disposed on a surface of the first chip and being fixed to the second chip. Martin et al. discloses a package for sealing an integrated circuit die comprising, as illustrated in

Application/Control Number: 09/100,838

Art Unit: 2856

Figures 2 and 4, a first chip of semiconductor material 10; a sensing element 24 formed on the

chip; a hollow structure 36 enclosing the sensing element; a metal wall 30 disposed on the chip;

and a closure plate 32 made of metal or polymeric material is fixed to the metal wall. (See, pages

4-9). It would have been obvious to a person of ordinary skill in the art at the time of invention to

have readily recognize the advantages and desirability of employing the hollow structure having a

metal wall disposed on a surface of the first chip and being fixed to the second chip as suggested

by Martin et al. to the device of Otani et al. since to enclose a sensing element is well known in

the art to provide protection to the sensing element and to prevent external noises and particulates

from interfering with the detected signal from the sensing element. (See, page 2 of Martin et al.).

With regards to claims 2-7, Otani et al. further discloses conductive pads for electrical

connection to the processing circuit. (See, column 5, lines 13-22) while Martin et al. also further

discloses ballbonds 16 and wirebonds 18 for connection to the sensing element for transmitting

electrical signals to the processing circuit..

With regards to claims 12-13 and 15-20, the claims are commensurate in scope with

claims 1-7 and are rejected for the same reasons as set forth above.

Response to Amendment

3. Applicant's arguments with respect to claims 1-7 and 12, 13 and 15-20 have been

considered but are moot in view of the new ground(s) of rejection.

Page 3

Application/Control Number: 09/100,838

Art Unit: 2856

Page 4

Conclusion

4. Applicant's amendment necessitated the new ground(s) of rejection presented in this Office

action. Accordingly, THIS ACTION IS MADE FINAL. See MPEP § 706.07(a). Applicant is

reminded of the extension of time policy as set forth in 37 CAR 1.136(a).

A shortened statutory period for reply to this final action is set to expire THREE

MONTHS from the mailing date of this action. In the event a first reply is filed within TWO

MONTHS of the mailing date of this final action and the advisory action is not mailed until after

the end of the THREE-MONTH shortened statutory period, then the shortened statutory period

will expire on the date the advisory action is mailed, and any extension fee pursuant to 37

CAR 1.136(a) will be calculated from the mailing date of the advisory action. In no event,

however, will the statutory period for reply expire later than SIX MONTHS from the date of this

final action.

5. Any inquiry concerning this communication or earlier communications from the examiner

should be directed to Helen Kwok whose telephone number is (703) 308-8149.

Helen C. Kwok

Art Unit 2856

hck

April 9, 2001